# **BLF6G20LS-140**

Power LDMOS transistor

Rev. 2 — 1 September 2015



### 1. Product profile

### 1.1 General description

140 W LDMOS power transistor for base station applications at frequencies from 1800 MHz to 2000 MHz.

#### Table 1.Typical performance

RF performance at  $T_{case} = 25 \ ^{\circ}C$  in a common source class-AB production test circuit.

| Mode of operation | f            | $V_{\text{DS}}$ | P <sub>L(AV)</sub> | Gp   | $\eta_D$ | IMD3                 | ACPR                 |
|-------------------|--------------|-----------------|--------------------|------|----------|----------------------|----------------------|
|                   | (MHz)        | (V)             | (W)                | (dB) | (%)      | (dBc)                | (dBc)                |
| 2-carrier W-CDMA  | 1930 to 1990 | 28              | 35.5               | 16.5 | 30       | -37 <mark>[1]</mark> | -40 <mark>[1]</mark> |

 Test signal: 3GPP; test model 1; 64 DPCH; PAR = 7 dB at 0.01 % probability on CCDF per carrier; carrier spacing 10 MHz.

#### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

### 1.2 Features

- Typical 2-carrier W-CDMA performance at frequencies of 1930 MHz and 1990 MHz, a supply voltage of 28 V and an I<sub>Dq</sub> of 1000 mA:
  - Average output power = 35.5 W
  - Power gain = 16.5 dB (typ)
  - Efficiency = 30 %
  - ◆ IMD3 = -37 dBc
  - ♦ ACPR = -40 dBc
- Easy power control
- Integrated ESD protection
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- Designed for broadband operation (1800 MHz to 2000 MHz)
- Internally matched for ease of use
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

### **1.3 Applications**

RF power amplifiers for GSM, GSM EDGE, W-CDMA and CDMA base stations and multi carrier applications in the 1800 MHz to 2000 MHz frequency range

### 2. Pinning information

| Pin | Description |            | Simplified outline | Graphical symbol                        |
|-----|-------------|------------|--------------------|---|
| 1   | drain       |            |                    |   |
| 2   | gate        |            |                    | 1<br>لــــا                             |
| 3   | source      | <u>[1]</u> | 2                  | 2 – – – – – – – – – – – – – – – – – – – |

[1] Connected to flange.

### 3. Ordering information

| Table 3. Ordering inf | ormation |
|-----------------------|----------|
|-----------------------|----------|

| Type number   | Package |   |         |
|---------------|---------|---|---------|
|               | Name    | Description                                     | Version |
| BLF6G20LS-140 | -       | earless flanged LDMOST ceramic package; 2 leads | SOT502B |

### 4. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol           | Parameter            | Conditions | Min  | Max  | Unit |
|------------------|----------------------|------------|------|------|------|
| V <sub>DS</sub>  | drain-source voltage |            | -    | 65   | V    |
| V <sub>GS</sub>  | gate-source voltage  |            | -0.5 | +13  | V    |
| I <sub>D</sub>   | drain current        |            | -    | 39   | А    |
| T <sub>stg</sub> | storage temperature  |            | -65  | +150 | °C   |
| Tj               | junction temperature |            | -    | 225  | °C   |

### 5. Thermal characteristics

| Table 5.                | Thermal characteristics                  |                                  |      |      |
|-------------------------|--|----------------------------------|------|------|
| Symbol                  | Parameter                                | Conditions                       | Тур  | Unit |
| R <sub>th(j-case)</sub> | thermal resistance from junction to case | $T_{case}$ = 80 °C; $P_L$ = 35 W | 0.49 | K/W  |

#### Characteristics 6.

| <b>Table 6.</b><br><i>T<sub>j</sub></i> = <i>25 ℃</i> | <b>Characteristics</b><br><i>Cunless otherwise specified.</i> |  |      |      |      |      |
|---|---|--|------|------|------|------|
| Symbol  | Parameter   | Conditions   | Min  | Тур  | Мах  | Unit |
| V <sub>(BR)DSS</sub>                                  | drain-source breakdown<br>voltage                             | V <sub>GS</sub> = 0 V; I <sub>D</sub> = 0.5 mA                     | 65   | -    | -    | V    |
| V <sub>GS(th)</sub>                                   | gate-source threshold voltage                                 | $V_{DS}$ = 10 V; I <sub>D</sub> = 216 mA                           | 1.4  | 2    | 2.4  | V    |
| $V_{GSq}$   | gate-source quiescent voltage                                 | V <sub>DS</sub> = 28 V;<br>I <sub>D</sub> = 1000 mA                | 1.53 | 2    | 2.53 | V    |
| I <sub>DSS</sub>                                      | drain leakage current   | $V_{GS}$ = 0 V; $V_{DS}$ = 28 V                                    | -    | -    | 5    | μA   |
| I <sub>DSX</sub>                                      | drain cut-off current   | $V_{GS} = V_{GS(th)} + 3.75 \text{ V};$<br>$V_{DS} = 10 \text{ V}$ | 31   | 39   | -    | А    |
| I <sub>GSS</sub>                                      | gate leakage current  | V <sub>GS</sub> = 13 V; V <sub>DS</sub> = 0 V                      | -    | -    | 450  | nA   |
| 9 <sub>fs</sub>                                       | forward transconductance                                      | V <sub>DS</sub> = 10 V; I <sub>D</sub> = 10.8 A                    | 9.7  | 13.5 | 15   | S    |
| R <sub>DS(on)</sub>                                   | drain-source on-state resistance                              | $V_{GS} = V_{GS(th)} + 3.75 V;$<br>$I_D = 7.56 A$                  | -    | 0.07 | -    | Ω    |
| C <sub>rs</sub>                                       | feedback capacitance  | V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 28 V;<br>f = 1 MHz        | -    | 3.57 | -    | pF   |

#### **Application information** 7.

#### Table 7. **Application information**

Mode of operation: 2-carrier W-CDMA; PAR 7 dB at 0.01 % probability on CCDF; 3GPP test model 1; 1-64 PDPCH; f<sub>1</sub> = 1932.5 MHz; f<sub>2</sub> = 1942.5 MHz; f<sub>3</sub> = 1977.5 MHz; f<sub>4</sub> = 1987.5 MHz; RF performance at  $V_{DS}$  = 28 V;  $I_{Dq}$  = 1000 mA;  $T_{case}$  = 25 °C; unless otherwise specified; in a class-AB production test circuit.

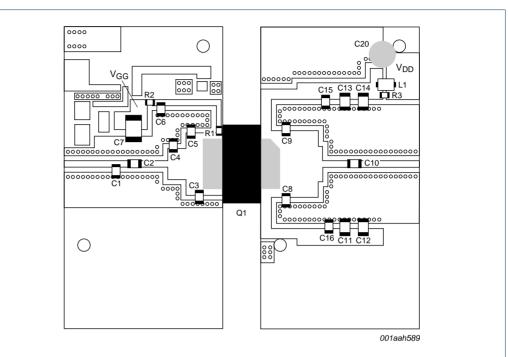
| Symbol           | Parameter                              | Conditions                  | Min  | Тур  | Max | Unit |
|------------------|--|-----------------------------|------|------|-----|------|
| $P_{L(AV)}$      | average output power                   |                             | -    | 35.5 | -   | W    |
| G <sub>p</sub>   | power gain                             | P <sub>L(AV)</sub> = 35.5 W | 15.5 | 16.5 | -   | dB   |
| RL <sub>in</sub> | input return loss                      | P <sub>L(AV)</sub> = 35.5 W | -    | 8    | 5   | dB   |
| $\eta_D$         | drain efficiency                       | P <sub>L(AV)</sub> = 35.5 W | 27   | 30   | -   | %    |
| IMD3             | third order intermodulation distortion | P <sub>L(AV)</sub> = 35.5 W | -    | -37  | -35 | dBc  |
| ACPR             | adjacent channel power ratio           | P <sub>L(AV)</sub> = 35.5 W | -    | -40  | -38 | dBc  |

### 7.1 Ruggedness in class-AB operation

The BLF6G20LS-140 is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions:  $V_{DS}$  = 28 V;  $I_{Da}$  = 1000 mA; P<sub>L</sub> = 140 W (CW); f = 1990 MHz.

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### 8. Test information



The striplines are on a double copper-clad Taconic RF35 Printed-Circuit Board (PCB) with  $\varepsilon_r$  = 3.5 and thickness = 0.76 mm. See Table 8 for list of components.

#### Fig 1. Component layout

#### Table 8. List of components (see Figure 1)

| Component          | Description                       | Value        |     | Remarks                                  |
|--------------------|-----------------------------------|--------------|-----|--|
| C1                 | multilayer ceramic chip capacitor | 0.5 pF       | [1] |  |
| C2                 | multilayer ceramic chip capacitor | 10 pF        | [2] |  |
| C3                 | multilayer ceramic chip capacitor | 0.9 pF       | [2] |  |
| C4                 | multilayer ceramic chip capacitor | 1.1 pF       | [2] |  |
| C5                 | multilayer ceramic chip capacitor | 1.4 pF       | [2] |  |
| C6                 | multilayer ceramic chip capacitor | 15 pF        | [2] |  |
| C7                 | multilayer ceramic chip capacitor | 10 μF; 50 V  |     | TDK C5750X7R1H106M or equivalent         |
| C8, C9             | multilayer ceramic chip capacitor | 1.2 pF       | [2] |  |
| C10                | multilayer ceramic chip capacitor | 13 pF        | [2] |  |
| C11, C12, C13, C14 | multilayer ceramic chip capacitor | 4.7 μF; 50 V |     | TDK C4532X7R1H475M or equivalent         |
| C20                | electrolytic capacitor            | 220 μF; 35 V |     |  |
| L1                 | ferrite SMD bead                  | -            |     | Ferroxcube BDS 3/3/8.9-4S2 or equivalent |
| Q1                 | BLF6G20LS-140                     | -            |     |  |
| R1                 | SMD resistor                      | 0 Ω          |     |  |
| R2                 | SMD resistor                      | 3.3 kΩ       |     |  |
| R3                 | SMD resistor                      | 9.1 Ω        |     |  |

[1] American Technical Ceramics type 100A or capacitor of same quality.

[2] American Technical Ceramics type 100B or capacitor of same quality.

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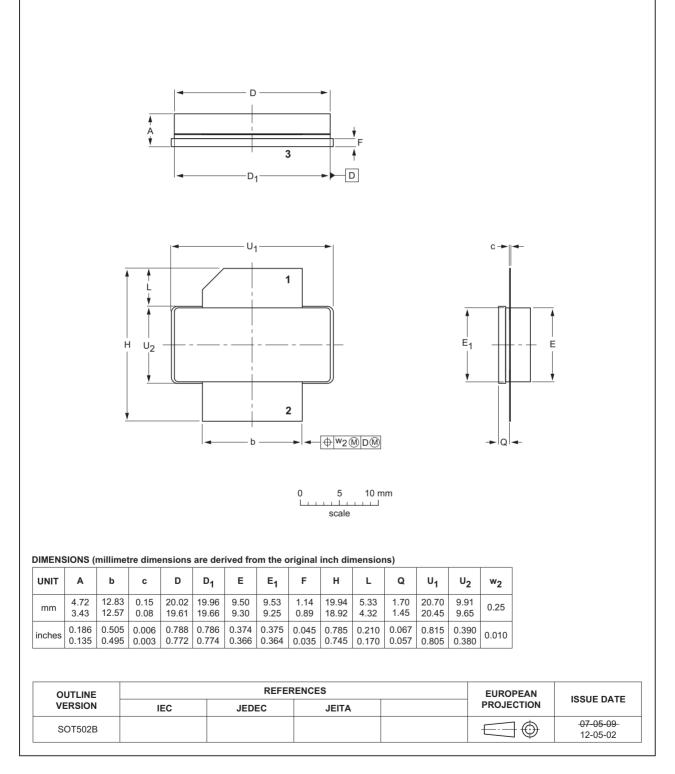
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### 9. Package outline

#### Earless flanged ceramic package; 2 leads

SOT502B



#### Fig 2. Package outline SOT502B

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## **10. Abbreviations**

| Table 9. | Abbreviations |   |
|----------|---------------|---|
| Acronym  |               | Description   |
| 3GPP     |               | Third Generation Partnership Project                    |
| CCDF     |               | Complementary Cumulative Distribution Function          |
| CDMA     |               | Code Division Multiple Access                           |
| CW       |               | Continuous Wave   |
| DPCH     |               | Dedicated Physical CHannel                              |
| EDGE     |               | Enhanced Data rates for GSM Evolution                   |
| GSM      |               | Global System for Mobile communications                 |
| LDMOS    |               | Laterally Diffused Metal Oxide Semiconductor            |
| LDMOST   |               | Laterally Diffused Metal-Oxide Semiconductor Transistor |
| PAR      |               | Peak-to-Average power Ratio                             |
| PDPCH    |               | transmission Power of the Dedicated Physical CHannel    |
| RF       |               | Radio Frequency   |
| SMD      |               | Surface Mounted Device                                  |
| VSWR     |               | Voltage Standing Wave Ratio                             |
| W-CDMA   |               | Wideband Code Division Multiple Access                  |

## 11. Revision history

#### Table 10. Revision history

| Document ID     | Release date   | Data sheet status  | Change notice | Supersedes      |
|-----------------|--|--------------------|---------------|-----------------|
| BLF6G20LS-140#2 | 20150901   | Product data sheet | -             | BLF6G20LS-140_1 |
| Modifications:  | • The format of this document has been redesigned to comply with the new identity guidelines of Ampleon. |                    |               |                 |
|                 | <ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>             |                    |               |                 |
| BLF6G20LS-140_1 | 20090227   | Product data sheet | -             | -               |

## 12. Legal information

### **12.1 Data sheet status**

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |  |
|-----------------------------------|-------------------------------|---|--|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |  |
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